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AF

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: MS AF, Commissioner for Patents, P.O. Box 1450, Apxandria, VA 22313-1450, on the date shown below.

Dated: March 29, 2005

gnature:

Docket No.: 30205/39380

(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Jong Goo Jung et al.

Application No.: 10/603,976

Confirmation No.: 3741

Filed: June 25, 2003

Art Unit: 2813

For: CMP SLURRY COMPOSITION FOR OXIDE

FILMS AND METHODS FOR FORMING

METAL LINE CONTACT PLUGS USING THE

**SAME** 

Examiner: Stephen W. Smoot

## **AMENDMENT AFTER FINAL ACTION (37 C.F.R. SECTION 1.116)**

MS AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

## INTRODUCTORY COMMENTS

In response to the final office action dated January 6, 2005, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.